



# **Multilayer ceramic capacitors**

Array capacitors, C0G

Date: October 2006

## Ordering code system

  
**B37830**

  
**R**

  
**0**

  
**101**

  
**K**

  
**0**

  
**2**

  
**1**

**Packaging**  
1  $\triangleq$  cardboard tape, 180-mm reel  
3  $\triangleq$  cardboard tape, 330-mm reel

2  $\triangleq$  2-fold array

4  $\triangleq$  4-fold array

**Internal coding:** 0 or decimal place for cap. values <10 pF

**Capacitance tolerance**  
  
J  $\triangleq \pm 5\%$   
**K  $\triangleq \pm 10\%$  (standard for C0G)**  
M  $\triangleq \pm 20\%$  (standard for X7R)

**Capacitance, coded**    100  $\triangleq 10 \cdot 10^0$  pF = 10 pF  
(example)                    101  $\triangleq 10 \cdot 10^1$  pF = 100 pF  
                                     220  $\triangleq 22 \cdot 10^0$  pF = 22 pF

| Rated voltage | Rated voltage [VDC] | 16 | 25 | 50 |
|---------------|---------------------|----|----|----|
|               | Code                | 9  | 0  | 5  |
|               |                     |    |    |    |

**Internal coding**    "R" indicates array capacitor

| Type and size            |                            |        |  |
|--------------------------|----------------------------|--------|--|
| Chip size<br>(inch / mm) | Temperature characteristic |        |  |
|                          | C0G                        | X7R    |  |
| <b>0405</b> / 1012       | B37830                     | B37831 |  |
| <b>0508</b> / 1220       | B37940                     | B37941 |  |
| <b>0612</b> / 1632       | B37871                     | B37872 |  |

## Features

- Reduction of mounting time and mounting costs
- Space saving on the PCB
- To AEC-Q200

## Applications

- Suitable for electronic circuits with parallel line layout
- Coupling and filtering, particularly in RF circuits
- Resonant circuits
- Filter circuits

## Termination

- For soldering: Nickel barrier terminations (Ni)

## Options

- Alternative capacitance tolerances available on request

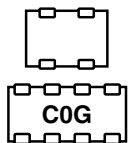
## Delivery mode

- Cardboard tape, 180-mm and 330-mm reel available

## Electrical data

|                                                |               |                               |     |
|------------------------------------------------|---------------|-------------------------------|-----|
| Temperature characteristic                     |               | C0G                           |     |
| Climatic category (IEC 60068-1)                |               | 55/125/56                     |     |
| Standard                                       |               | EIA                           |     |
| Dielectric                                     |               | Class 1                       |     |
| Rated voltage                                  | $V_R$         | 25, 50                        | VDC |
| Test voltage                                   | $V_{test}$    | $2.5 \cdot V_R / 5 \text{ s}$ | VDC |
| Capacitance range / E series                   | $C_R$         | 10 pF ... 1.0 nF (E6)         |     |
| Temperature coefficient                        |               | $0 \pm 30 \cdot 10^{-6}/K$    |     |
| Dissipation factor (limit value)               | $\tan \delta$ | $< 1.0 \cdot 10^{-3}$         |     |
| Insulation resistance <sup>1)</sup> at + 25 °C | $R_{ins}$     | $> 10^5$                      | MΩ  |
| Insulation resistance <sup>1)</sup> at +125 °C | $R_{ins}$     | $> 10^4$                      | MΩ  |
| Time constant <sup>1)</sup> at + 25 °C         | $\tau$        | $> 1000$                      | s   |
| Time constant <sup>1)</sup> at +125 °C         | $\tau$        | $> 100$                       | s   |
| Operating temperature range                    | $T_{op}$      | -55 ... +125                  | °C  |
| Ageing                                         |               | none                          |     |

1) For  $C_R > 10 \text{ nF}$  the time constant  $\tau = C \cdot R_{ins}$  is given.



## Multilayer ceramic capacitors

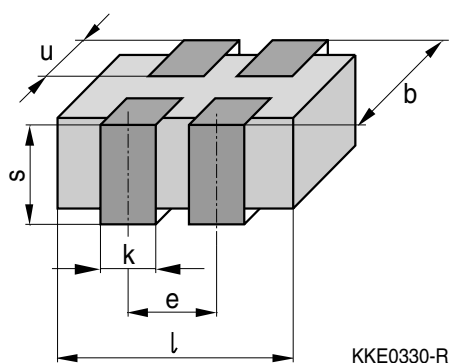
### C0G

### Capacitance tolerances

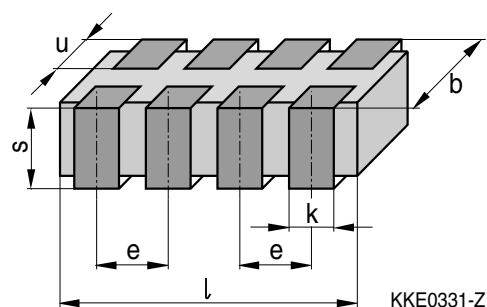
|             |           |                 |
|-------------|-----------|-----------------|
| Code letter | J         | K<br>(standard) |
| Tolerance   | $\pm 5\%$ | $\pm 10\%$      |

### Dimensional drawing

2-fold array (case size 0405)



4-fold array (case sizes 0508 and 0612)



### Dimensions (mm)

|                          | 2-fold array    | 4-fold array     |                  |
|--------------------------|-----------------|------------------|------------------|
| Case size (inch)<br>(mm) | 0405<br>1012    | 0508<br>1220     | 0612<br>1632     |
| l                        | $1.37 \pm 0.15$ | $2.00 \pm 0.2$   | $3.20 \pm 0.2$   |
| b                        | $1.00 +0/-0.15$ | $1.25 \pm 0.15$  | $1.60 \pm 0.2$   |
| s                        | 0.70 max.       | $0.85 \pm 0.1$   | $0.85 \pm 0.1$   |
| k                        | $0.36 \pm 0.1$  | $0.30 \pm 0.1$   | $0.40 \pm 0.15$  |
| e                        | 0.64            | $0.50 \pm 0.1$   | $0.80 \pm 0.15$  |
| u                        | $0.20 \pm 0.1$  | $0.20 +0.3/-0.1$ | $0.20 +0.3/-0.1$ |

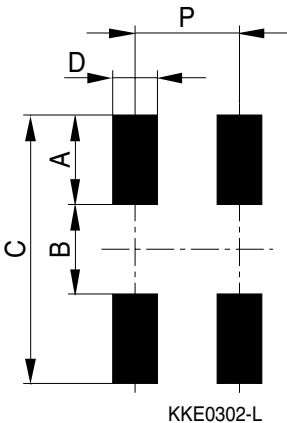
Tolerances to CECC 32101-801

# Multilayer ceramic capacitors

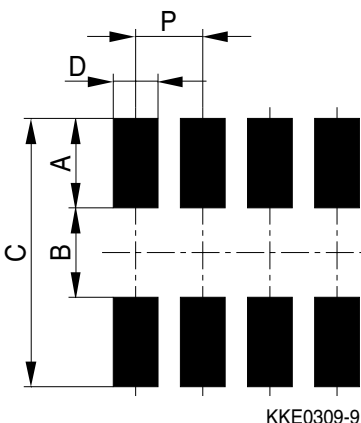
## C0G

### Recommended solder pad

2-fold array (case size 0405)



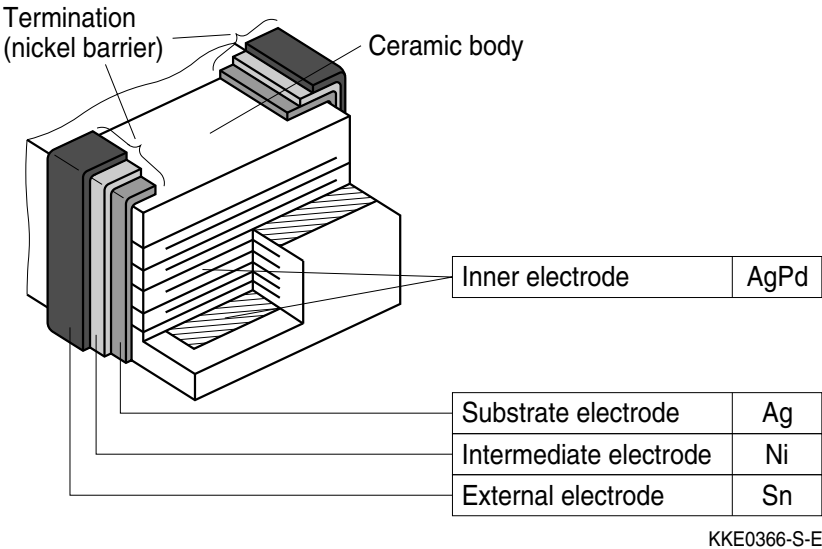
4-fold array (case sizes 0508 and 0612)

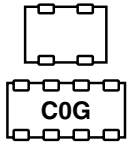


### Recommended dimensions (mm) for reflow soldering

| Case size | (inch/mm) | Type         | A                | B                | C                | D                | P              |
|-----------|-----------|--------------|------------------|------------------|------------------|------------------|----------------|
| 0405/1012 |           | 2-fold array | 0.50 ...<br>0.55 | 0.45 ...<br>0.50 | 1.45 ...<br>1.60 | 0.30 ...<br>0.35 | 0.64<br>±0.10  |
| 0508/1220 |           | 4-fold array | 0.50 ...<br>0.70 | 0.60 ...<br>0.70 | 1.60 ...<br>2.10 | 0.25 ...<br>0.35 | 0.50<br>±0.005 |
| 0612/1632 |           | 4-fold array | 0.70 ...<br>0.90 | 0.80 ...<br>1.00 | 2.20 ...<br>2.80 | 0.30 ...<br>0.40 | 0.80<br>±0.005 |

### Termination





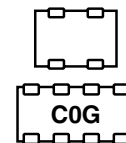
## Multilayer ceramic capacitors

### C0G

#### Product range array capacitors, C0G

|                    | 2-fold arrays |  | 4-fold arrays |  |        |  |
|--------------------|---------------|--|---------------|--|--------|--|
| Size <sup>1)</sup> |               |  |               |  |        |  |
| inch               | 0405          |  | 0508          |  | 0612   |  |
| mm                 | 1012          |  | 1220          |  | 1632   |  |
| Type               | B37830        |  | B37940        |  | B37871 |  |
| $V_R$ (VDC)        |               |  |               |  |        |  |
| $C_R$              | 25            |  | 50            |  | 50     |  |
| 10 pF              |               |  |               |  |        |  |
| 15 pF              |               |  |               |  |        |  |
| 22 pF              |               |  |               |  |        |  |
| 33 pF              |               |  |               |  |        |  |
| 47 pF              |               |  |               |  |        |  |
| 68 pF              |               |  |               |  |        |  |
| 100 pF             |               |  |               |  |        |  |
| 150 pF             |               |  |               |  |        |  |
| 180 pF             |               |  |               |  |        |  |
| 220 pF             |               |  |               |  |        |  |
| 330 pF             |               |  |               |  |        |  |
| 470 pF             |               |  |               |  |        |  |
| 680 pF             |               |  |               |  |        |  |
| 1.0 nF             |               |  |               |  |        |  |

1)  $l \times b$  (inch) /  $l \times b$  (mm)



|                               |
|-------------------------------|
| Multilayer ceramic capacitors |
| C0G; 0405                     |

### Ordering codes and packing for C0G arrays, 25 VDC, nickel barrier terminations

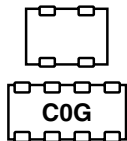
| C <sub>R</sub> <sup>1)</sup> | Ordering code <sup>2)</sup> | Chip thickness<br>mm | Cardboard tape,<br>Ø 180-mm reel | Cardboard tape,<br>Ø 330-mm reel |
|------------------------------|-----------------------------|----------------------|----------------------------------|----------------------------------|
|                              |                             |                      | * $\triangleq$ 1                 | * $\triangleq$ 3                 |
|                              |                             |                      | pcs/reel                         | pcs/reel                         |

#### Case size 0405, 25 VDC, 2-fold arrays

|        |                 |           |      |       |
|--------|-----------------|-----------|------|-------|
| 10 pF  | B37830R0100K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 15 pF  | B37830R0150K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 22 pF  | B37830R0220K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 33 pF  | B37830R0330K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 47 pF  | B37830R0470K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 68 pF  | B37830R0680K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 100 pF | B37830R0101K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 150 pF | B37830R0151K02* | 0.6 ± 0.1 | 5000 | 20000 |
| 180 pF | B37830R0181K02* | 0.6 ± 0.1 | 5000 | 20000 |

1) Other capacitance values on request.

2) The table contains the ordering codes for the standard capacitance tolerance.  
For other available capacitance tolerances see page 128.



## Multilayer ceramic capacitors

### C0G; 0508 and 0612

#### Ordering codes and packing for C0G arrays, 50 VDC, nickel barrier terminations

| C <sub>R</sub> <sup>1)</sup> | Ordering code <sup>2)</sup> | Chip thickness<br>mm | Cardboard tape,<br>Ø 180-mm reel | Cardboard tape,<br>Ø 330-mm reel |
|------------------------------|-----------------------------|----------------------|----------------------------------|----------------------------------|
|                              |                             |                      | * $\triangleq$ 1                 | * $\triangleq$ 3                 |
|                              |                             |                      | pcs/reel                         | pcs/reel                         |

#### Case size 0508, 50 VDC, 4-fold arrays

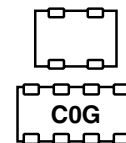
|        |                 |                |      |       |
|--------|-----------------|----------------|------|-------|
| 10 pF  | B37940R5100K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 15 pF  | B37940R5150K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 22 pF  | B37940R5220K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 33 pF  | B37940R5330K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 47 pF  | B37940R5470K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 68 pF  | B37940R5680K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 100 pF | B37940R5101K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 150 pF | B37940R5151K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 220 pF | B37940R5221K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |

#### Case size 0612, 50 VDC, 4-fold arrays

|        |                 |                |      |       |
|--------|-----------------|----------------|------|-------|
| 10 pF  | B37871R5100K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 15 pF  | B37871R5150K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 22 pF  | B37871R5220K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 33 pF  | B37871R5330K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 47 pF  | B37871R5470K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 68 pF  | B37871R5680K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 100 pF | B37871R5101K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 150 pF | B37871R5151K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 220 pF | B37871R5221K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 330 pF | B37871R5331K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 470 pF | B37871R5471K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 680 pF | B37871R5681K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |
| 1.0 nF | B37871R5102K04* | 0.85 $\pm$ 0.1 | 4000 | 16000 |

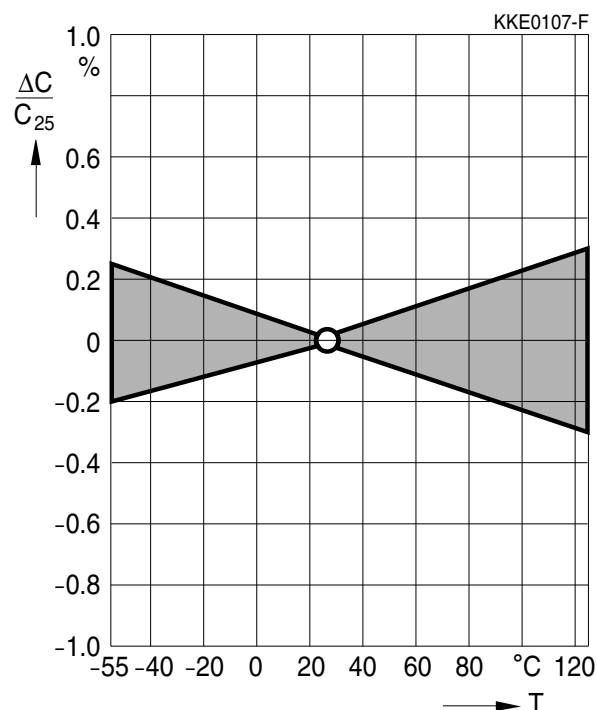
1) Other capacitance values on request.

2) The table contains the ordering codes for the standard capacitance tolerance.  
For other available capacitance tolerances see page 128.

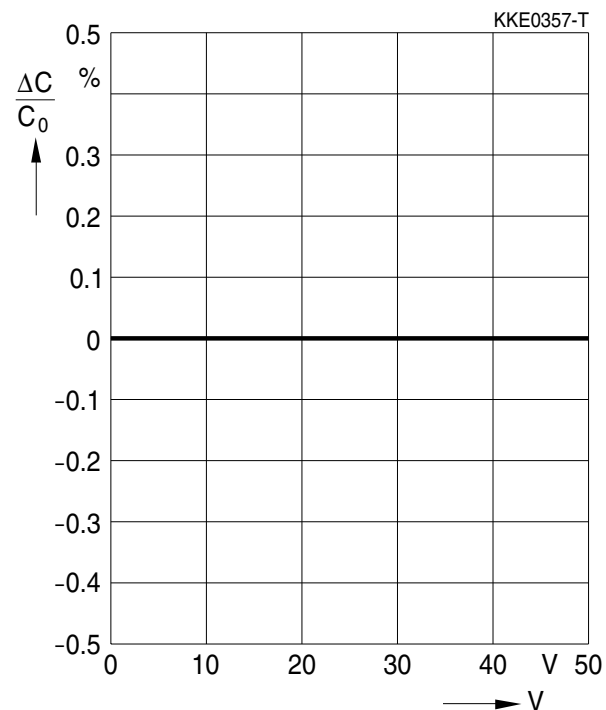


## Typical characteristics<sup>1)</sup>

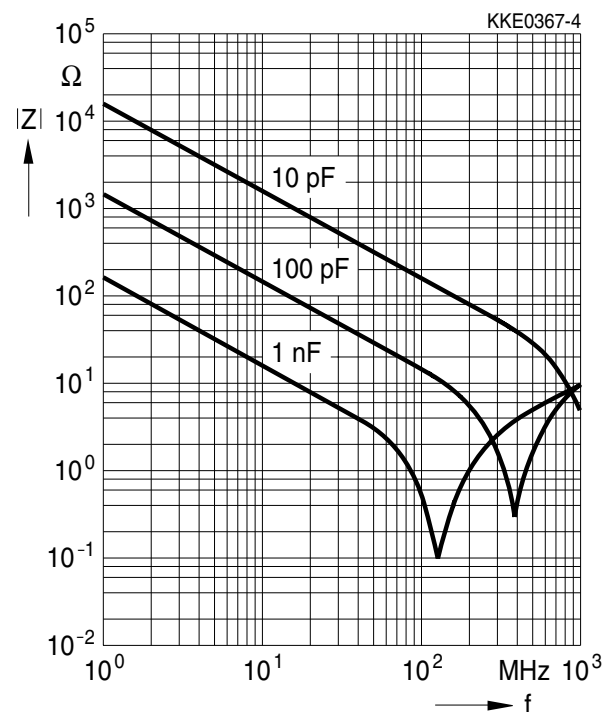
Capacitance change  $\Delta C/C_{25}$  versus temperature  $T$  (tolerance range  $\pm 0.2\%$ )



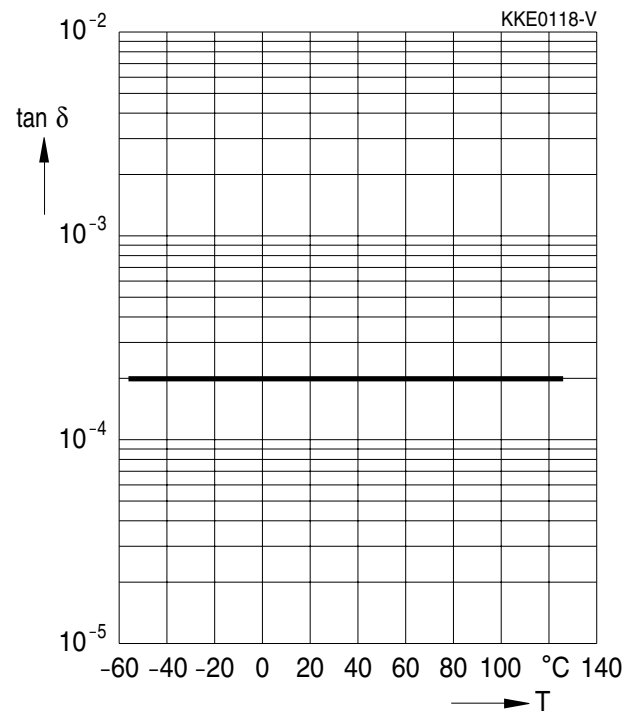
Capacitance change  $\Delta C/C_0$  versus superimposed DC voltage  $V$



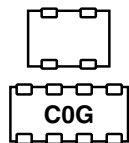
Impedance  $|Z|$  versus frequency  $f$



Dissipation factor  $\tan \delta$  versus temperature  $T$



1) For more detailed information on frequency behavior and characteristics see [www.epcos.com/mlcc\\_impedance](http://www.epcos.com/mlcc_impedance).

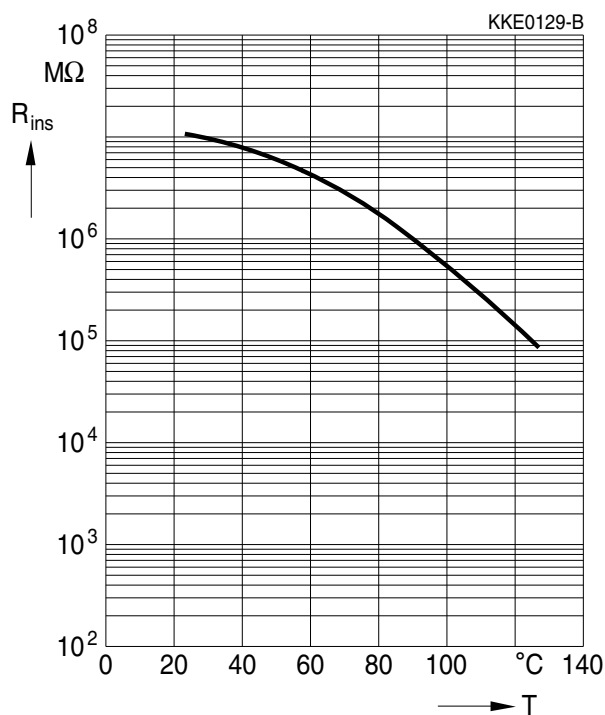


## Multilayer ceramic capacitors

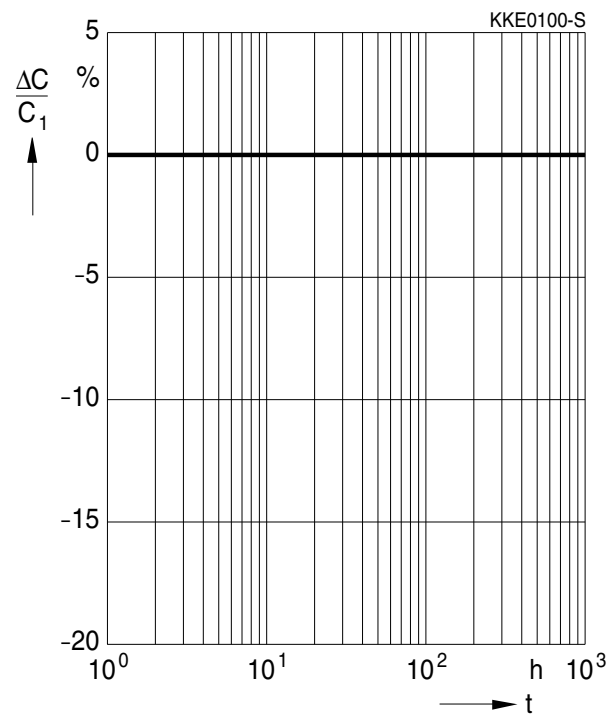
### C0G

#### Typical characteristics<sup>1)</sup>

Insulation resistance  $R_{ins}$  versus temperature  $T$



Capacitance change  $\Delta C/C_1$  versus time  $t$



1) For more detailed information on frequency behavior and characteristics see [www.epcos.com/mlcc\\_impedance](http://www.epcos.com/mlcc_impedance).

## Multilayer ceramic capacitors

### Cautions and warnings

#### Notes on the selection of ceramic capacitors

In the selection of ceramic capacitors, the following criteria must be considered:

1. Depending on the application, ceramic capacitors used to meet high quality requirements should at least satisfy the specifications to AEC-Q200. They must meet quality requirements going beyond this level in terms of ruggedness (e.g. mechanical, thermal or electrical) in the case of critical circuit configurations and applications (e.g. in safety-relevant applications such as ABS and airbag equipment or durable industrial goods).
2. At the connection to the battery or power supply (e.g. clamp 15 or 30 in the automobile) and at positions with stranding potential, to reduce the probability of short circuits following a fracture, two ceramic capacitors must be connected in series and/or a ceramic capacitor with integrated series circuit should be used. The MLSC from EPCOS contains such a series circuit in a single component.
3. Ceramic capacitors with the temperature characteristics Z5U and Y5V do not satisfy the requirements to AEC-Q200 and are mechanically and electrically less rugged than C0G or X7R/X8R ceramic capacitors. In applications that must satisfy high quality requirements, therefore, these capacitors should not be used as discrete components (see the chapter “Effects on mechanical, thermal and electrical stress”, point 1.4).
4. For ESD protection, preference should be given to the use of multilayer varistors (MLV) (see the chapter “Effects on mechanical, thermal and electrical stress”, point 1.4).
5. An application-specific derating or continuous operating voltage must be considered in order to cushion (unexpected) additional stresses (see the chapter “Reliability”).

#### The following should be considered in circuit board design

1. If technically feasible in the application, preference should be given to components having an optimal geometrical design.
2. At least FR4 circuit board material should be used.
3. Geometrically optimal circuit boards should be used, ideally those that cannot be deformed.
4. Ceramic capacitors must always be placed a sufficient minimum distance from the edge of the circuit board. High bending forces may be exerted there when the panels are separated and during further processing of the board (such as when incorporating it into a housing).
5. Ceramic capacitors should always be placed parallel to the possible bending axis of the circuit board.
6. No screw connections should be used to fix the board or to connect several boards. Components should not be placed near screw holes. If screw connections are unavoidable, they must be cushioned (for instance by rubber pads).

## Multilayer ceramic capacitors

### Cautions and warnings

#### **The following should be considered in the placement process**

1. Ensure correct positioning of the ceramic capacitor on the solder pad.
2. Caution when using casting, injection-molded and molding compounds and cleaning agents, as these may damage the capacitor.
3. Support the circuit board and reduce the placement forces.
4. A board should not be straightened (manually) if it has been distorted by soldering.
5. Separate panels with a peripheral saw, or better with a milling head (no dicing or breaking).
6. Caution in the subsequent placement of heavy or leaded components (e.g. transformers or snap-in components): danger of bending and fracture.
7. When testing, transporting, packing or incorporating the board, avoid any deformation of the board not to damage the components.
8. Avoid the use of excessive force when plugging a connector into a device soldered onto the board.
9. Ceramic capacitors must be soldered only by the mode (reflow or wave soldering) permissible for them (see the chapter "Soldering directions").
10. When soldering the most gentle solder profile feasible should be selected (heating time, peak temperature, cooling time) in order to avoid thermal stresses and damage.
11. Ensure the correct solder meniscus height and solder quantity.
12. Ensure correct dosing of the cement quantity.
13. Ceramic capacitors with an AgPd external termination are not suited for the lead-free solder process: they were developed only for conductive adhesion technology.

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

## Multilayer ceramic capacitors

### Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
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- Комплексную поставку.
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- Формирование склада под заказчика.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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